

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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1A, 50V - 1000V High Efficient Surface Mount Rectifiers

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- Fast switching for high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition



DO-214AC (SMA)





MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound, UL flammability classification rating 94V-0

Moisture sensitivity level: level 1, per J-STD-020 Part no. with suffix "H" means AEC-Q101 qualified

Packing code with suffix "G" means green compound (halogen-free) **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 2 whisker test **Polarity:** Indicated by cathode band **Weight:** 0.06 g (approximately)

CVMDOL	HS	HS	HS	HS	HS	HS	HS	HS	UNIT
SYMBOL	1 A	1B	1 D	1F	1 G	1J	1K	1 M	
V_{RRM}	50	100	200	300	400	600	800	1000	V
V_{RMS}	35	70	140	210	280	420	560	700	V
V_{DC}	50	100	200	300	400	600	800	1000	V
I _{F(AV)}	1					Α			
I _{FSM}	30				А				
V _F		1	.0		1.3		1.7		V
					5				
I_{R}	50							μA	
	150								
t _{rr}	50 75			ns					
CJ	20 15			pF					
$R_{\theta JA}$	70					°C/W			
T.	- 55 to +150				°C				
	SYMBOL VRRM VRMS VDC IF(AV) IFSM VF IR trr CJ Rejja	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	SYMBOL 1A 1B V _{RRM} 50 100 V _{RMS} 35 70 V _{DC} 50 100 I _{F(AV)} I _{FSM} V _F 1 I _R t _{rr} C _J C _J	SYMBOL HS 1B 1D V _{RRM} 50 100 200 V _{RMS} 35 70 140 V _{DC} 50 100 200 I _{F(AV)} 1.0 V _F 1.0 I _R 50 20 C _J 20 R _{θJA} 20	SYMBOL 1A 1B 1D 1F V _{RRM} 50 100 200 300 V _{RMS} 35 70 140 210 V _{DC} 50 100 200 300 I _{F(AV)} I _{FSM} 3 V _F 1.0 5 I _R 5 1 t _{rr} 50 50 C _J 20 7	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

 T_{STG}

Note 1: Pulse test with PW=300µs, 1% duty cycle

Storage temperature range

Note 2: Reverse Recovery Test Conditions: I_F =0.5A, I_R =1.0A, I_{RR} =0.25A

Note 3: Measured at 1 MHz and Applied Reverse Voltage of 4.0V D.C.

°C

- 55 to +150



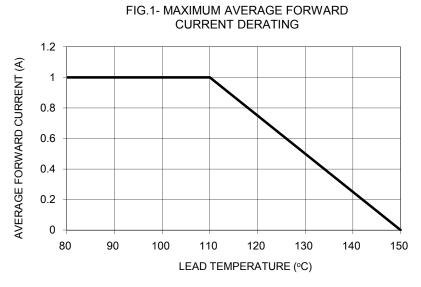
ORDERING INFORMATION						
PART NO.	PART NO.	PACKING CODE	PACKING CODE	PACKAGE	PACKING	
	SUFFIX		SUFFIX			
	Н	R3		SMA	1,800 / 7" Plastic reel	
		R2	G	SMA	7,500 / 13" Paper reel	
		M2		SMA	7,500 / 13" Plastic reel	
HS1x		F3		Folded SMA	1,800 / 7" Plastic reel	
(Note 1)		F2		Folded SMA	7,500 / 13" Paper reel	
		F4		Folded SMA	7,500 / 13" Plastic reel	
		E3		Clip SMA	1,800 / 7" Plastic reel	
		E2		Clip SMA	7,500 / 13" Plastic reel	

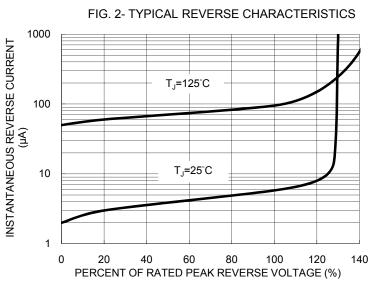
Note 1: "x" defines voltage from 50V (HS1A) to 1000V (HS1M)

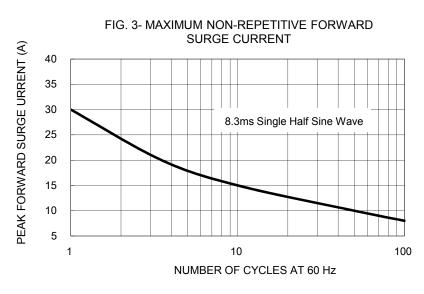
EXAMPLE					
PREFERRED PART NO.	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
HS1MHR3G	HS1M	Н	R3	G	AEC-Q101 qualified Green compound

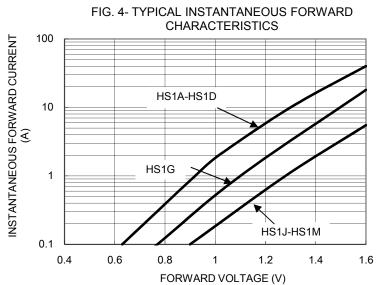
RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)











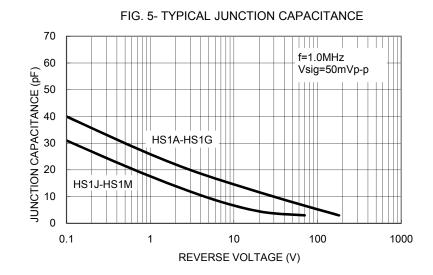
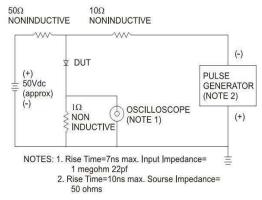
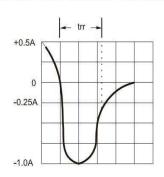
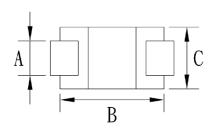


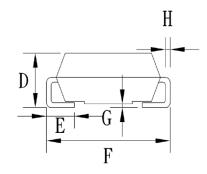
FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM





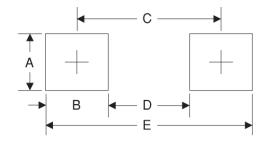
PACKAGE OUTLINE DIMENSIONS DO-214AC (SMA)





DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min	Max	Min	Max	
Α	1.27	1.58	0.050	0.062	
В	4.06	4.60	0.160	0.181	
С	2.29	2.83	0.090	0.111	
D	1.99	2.50	0.078	0.098	
Е	0.90	1.41	0.035	0.056	
F	4.95	5.33	0.195	0.210	
G	0.10	0.20	0.004	0.008	
Н	0.15	0.31	0.006	0.012	

SUGGESTED PAD LAYOUT



F =

Symbol	Unit (mm)	Unit (inch)
Α	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
E	5.45	0.215

MARKING DIAGRAM



P/N = Specific Device Code
G = Green Compound
YW = Date Code

Factory Code

Document Number: DS_D1410042



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